Vishay Siliconix

# P-Channel 60 V (D-S) MOSFET



## Marking code: AS

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	-60					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.216					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.288					
Q <sub>g</sub> typ. (nC)	4.4					
I <sub>D</sub> (A) <sup>d</sup>	-2.9					
Configuration	Single					

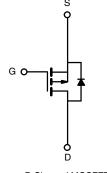
#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



#### **APPLICATIONS**

· Load switch



P-Channel MOSFET
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ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free	Si3459BDV-T1-E3
Lead (Pb)-free and halogen-free	Si3459BDV-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>iS</b> (T <sub>A</sub> = 25 °C, u	nless other	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-60	V	
Gate-source voltage		$V_{GS}$	± 20		
	T <sub>C</sub> = 25 °C		-2.9		
Continuous dusin surrent /T 150 °C)	T <sub>C</sub> = 70 °C	1 ,	-2.3		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-2.2 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C	1	-1.8 <sup>a, b</sup>	Α	
Pulsed drain current		I <sub>DM</sub> -8		1	
Continuous source drain diade current	T <sub>C</sub> = 25 °C		-2.9		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	l <sub>S</sub>	-1.7 <sup>a, b</sup>		
	T <sub>C</sub> = 25 °C		3.3	W	
Maximum power dissipation	T <sub>C</sub> = 70 °C	1 5	2.1		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2 <sup>a,b</sup>		
	T <sub>A</sub> = 70 °C	1	1.3 <sup>a, b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub> -55 to +150		90	
Soldering recommendations (peak temperature)			260	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient a, c	t ≤ 5 s	R <sub>thJA</sub>	53	62.5	°C/W	
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	32	38	C/ VV	

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 5 s
- c. Maximum under steady state conditions is 110 °C/W
- d. Based on  $T_C = 25$  °C



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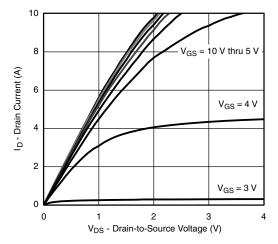
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						•
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-60	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	J		-65	-	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = -250 \ \mu A$	-1	-	-3	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zara gata valtaga drain aurrant		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$	-	-	-10	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$	-8	-	-	Α
Drain actives on state registance 3	Б	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -2.2 A	-	0.180	0.216	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$	-	0.240	0.288	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -15 \text{ V}, I_D = -2.2 \text{ A}$	-	4	-	S
Dynamic <sup>b</sup>						
Input capacitance	C <sub>iss</sub>		-	350	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	40	-	pF
Reverse transfer capacitance	C <sub>rss</sub>		-	30	-	1
Total gate charge	Qg	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -2.2 \text{ A}$	-	7.7	12	nC
			-	4.4	6.6	
Gate-source charge	Q <sub>qs</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -2.2 \text{ A}$	-	1.3	-	
Gate-drain charge	$Q_{qd}$		-	2.5	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	2	10	20	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	45	68	
Rise time	t <sub>r</sub>	$V_{DD} = -30 \text{ V}, R_L = 16.7 \Omega$	-	60	90	1
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong$ -1.8 A, $V_{GEN}=$ -4.5 V, $R_g=$ 1 $\Omega$	-	16	25	1
Fall time	t <sub>f</sub>		-	13	20	1
Turn-on delay time	t <sub>d(on)</sub>		-	5	10	ns
Rise time	t <sub>r</sub>	$V_{DD} = -30 \text{ V}, R_L = 16.7 \Omega$	-	12	20	= - -
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -1.8 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	18	30	
Fall time	t <sub>f</sub>		-	10	15	
<b>Drain-Source Body Diode Characteristi</b>	cs					
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-2.9	
Pulse diode forward current	I <sub>SM</sub>		-	-	-8	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -1.8 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	28	56	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = -1.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	35	70	nC
Reverse recovery fall time	t <sub>a</sub>	$T_{\rm J} = 25  ^{\circ}{\rm C}$	-	23	-	
Reverse recovery rise time	t <sub>b</sub>	-  · · · · ·		5		ns

## Notes

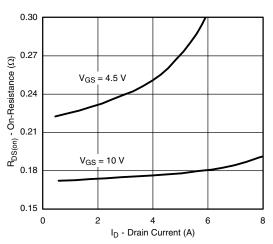
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

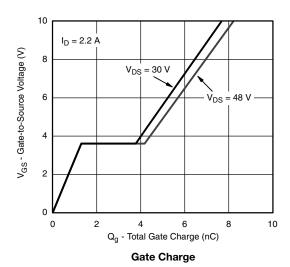


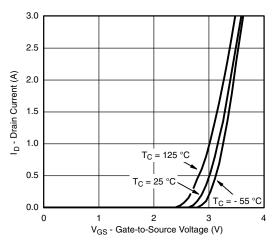


#### **Output Characteristics**

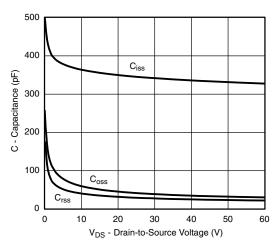


On-Resistance vs. Drain Current and Gate Voltage

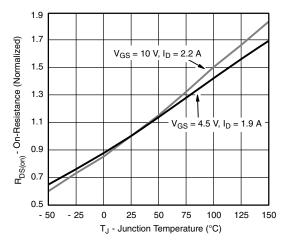




#### **Transfer Characteristics**

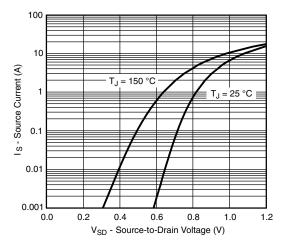


#### Capacitance

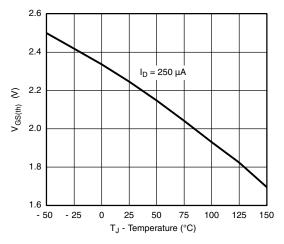


On-Resistance vs. Junction Temperature

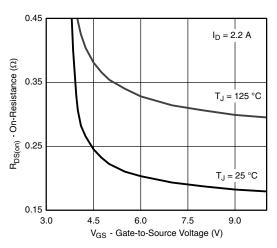




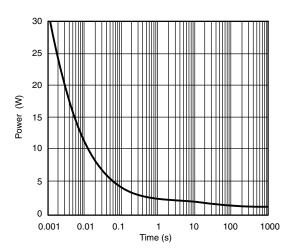
#### Source-Drain Diode Forward Voltage



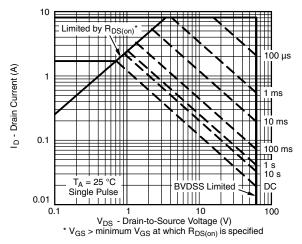
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

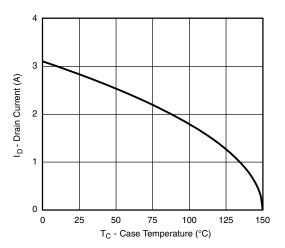


Single Pulse Power

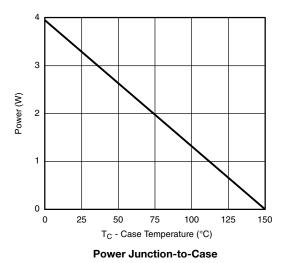


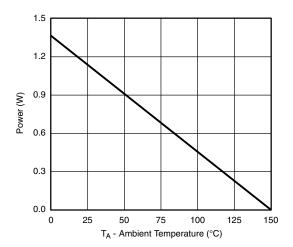
Safe Operating Area, Junction-to-Ambient





#### Current Derating a



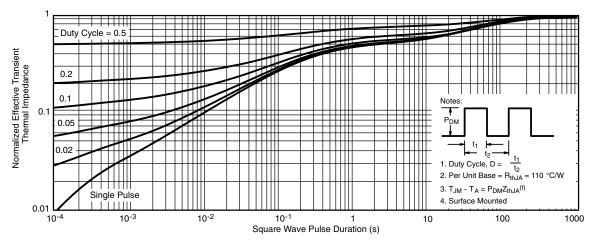


Power Junction-to-Ambient

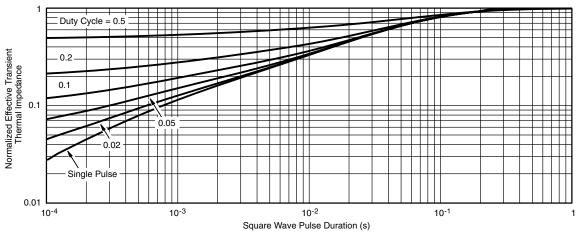
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

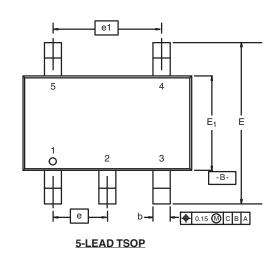
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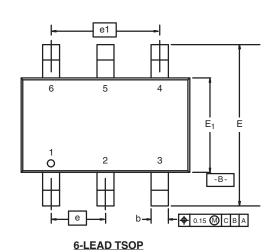


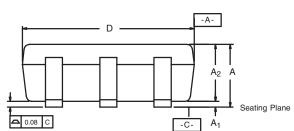


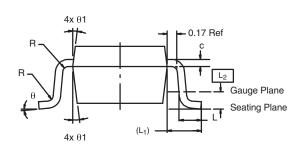
TSOP: 5/6-LEAD

**JEDEC Part Number: MO-193C** 









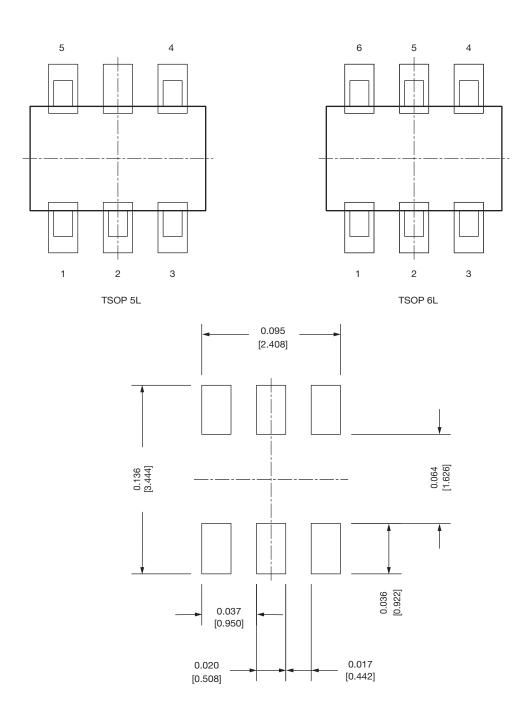
	MILLIMETERS			INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.91	-	1.10	0.036	-	0.043
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
С	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067
е		0.95 BSC		0.0374 BSC		
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L <sub>1</sub>	0.60 Ref			0.024 Ref		
L <sub>2</sub>	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
$\theta_1$	7° Nom 7° Nom					
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540						

Document Number: 71200

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# Recommended Land Pattern For TSOP-5L / TSOP-6L



#### Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022 DWG: 3010



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